

2SC1907

Silicon NPN Epitaxial Planar

REJ03G0694-0200 (Previous ADE-208-1059) Rev.2.00 Aug.10.2005

Application

UHF TV Tuner, Local oscillator

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Collector to base voltage	V _{CBO}	30	V
Collector to emitter voltage	V _{CEO}	19	V
Emitter to base voltage	V _{EBO}	2	V
Collector current	Ic	50	mA
Emitter current	I _E	-50	mA
Collector power dissipation	P _C	300	mW
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

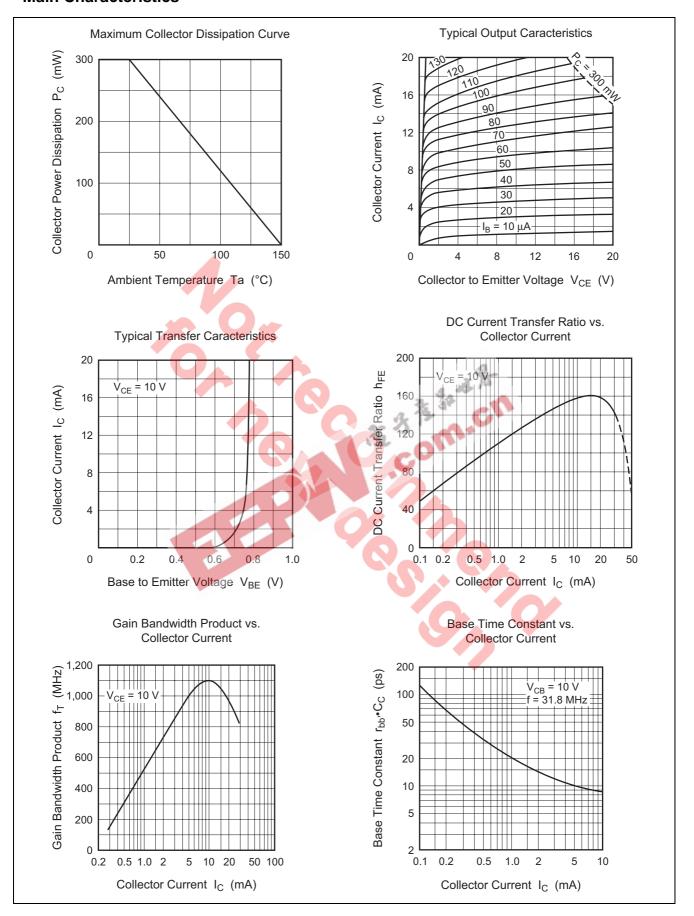
Electrical Characteristics

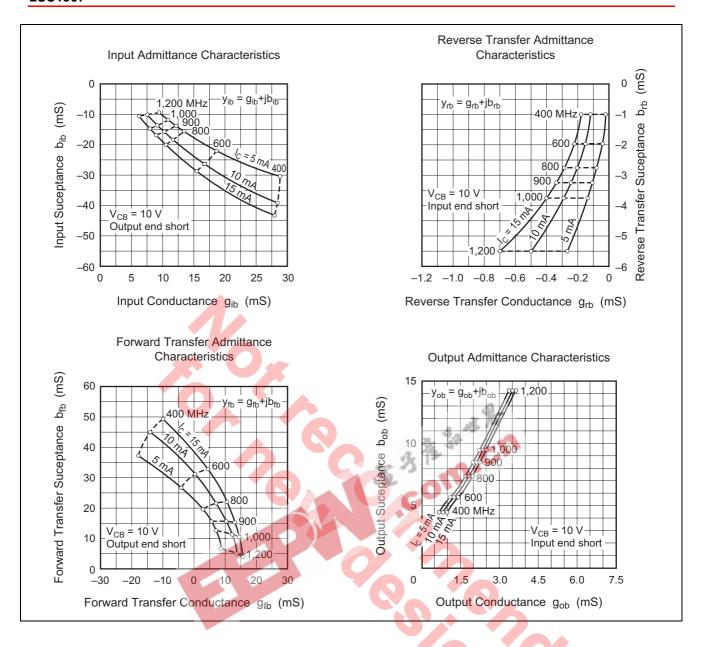
 $(Ta = 25^{\circ}C)$

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	V _{(BR)CBO}	30	_	_		$I_{C} = 10 \mu A, I_{E} = 0$
Collector to emitter breakdown voltage	V _{(BR)CEO}	19	_	_	V	$I_C = 3 \text{ mA}, R_{BE} = \infty$
Emitter to base breakdown voltage	V _{(BR)EBO}	2	_	_	V	$I_E = 10 \mu A, I_C = 0$
Collector cutoff current	I _{CBO}	_	_	0.5	μΑ	V _{CB} = 10 V, I _E = 0
DC current transfer ratio	h _{FE}	40	_	_		V _{CE} = 10 V, I _C = 10 mA
Collector to emitter saturation voltage	V _{CE(sat)}	_	0.2	1.0	V	I _C = 20 mA, I _B = 4 mA
Collector output capacitance	Cob	_	1.0	2.0	pF	V _{CB} = 10 V, I _E = 0, f = 1 MHz
Gain bandwidth product	f _T	900	1100	_	MHz	V _{CE} = 10 V, I _C = 10 mA
Base time constant	r _{bb'} • C _C	_	10	25	ps	V _{CB} = 10 V, I _C = 10 mA,
						f = 31.8 MHz
Oscillation output power	Pout	_	8	_	mW	$V_{CB} = 10 \text{ V}, I_{C} = 10 \text{ mA},$
						f = 930 MHz

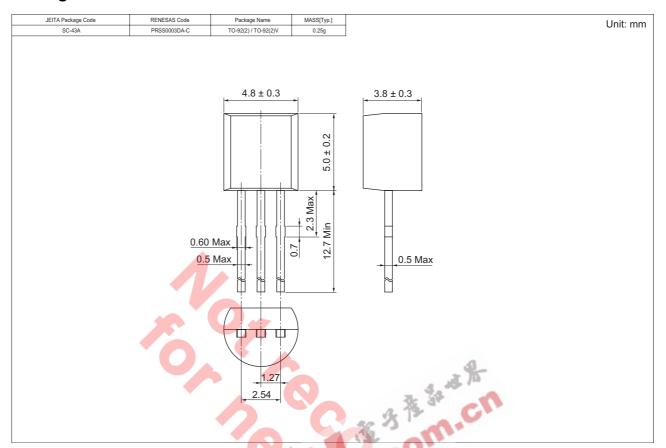


Main Characteristics





Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
2SC1907TZ-E	2500	Hold Box, Radial Taping

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